# LCD / LCM SPECIFICATION



WINSTAR Display Co.,Ltd. 華凌光電股份有限公司



WEB: <a href="http://www.winstar.com.tw">http://www.winstar.com.tw</a> E-mail: sales@winstar.com.tw

### **SPECIFICATION**

CUSTOMER :		
MODULE NO.:	WB12864F-Y	YYH-VZ#
APPROVED BY:		
( FOR CUSTOMER USE ONLY )	PCB VERSION:	DATA:

VERSION	DATE	REVISED PAGE NO.	SUMMARY
Е	2017/03/01		Modify VIL

## Winstar Display Co., LTD MODLE NO: 華凌光電股份有限公司

### DOC. FIRST ISSUE RECORDS OF REVISION **REVISED** VERSION **DATE SUMMARY** PAGE NO. 2009/04/13 First issue 0 2010/01/08 Modify RA6963 IC A Remove IC information 2015/03/27 Modify Electrical Characteristics ,Response Time & B/L information $\mathbf{C}$ 2015/07/28 Modify VDD-VSS=4.5~5.5V 2016/01/27 Modify Precautions in use D of LCD Modules & Static electricity test 2017/03/01 Modify VIL E

### **Contents**

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- 2.Precautions in use of LCD Modules
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### 1. Module Classification Information

W	<u>B</u>	<u>12864</u>	<u>F</u>	_	<u>Y</u>	<u>Y</u>	<u>H</u>	_	VZ#
1	2	3	4		(5)	6	7		8

① Brand: WINSTAR DISPLAY CORPORATION

② Display Type: H→Character Type, G→Graphic Type, X→TAB Type, O→COG Type

3 Display Font: 128 \* 64 dot

Model serials no.

 $\bigcirc$  Backlight Type : N $\rightarrow$ Without backlight T $\rightarrow$ LED, White S $\rightarrow$ LED, High light White

 $B \rightarrow EL$ , Blue green  $A \rightarrow LED$ , Amber  $L \rightarrow LED$ , Full color  $D \rightarrow EL$ , Green  $R \rightarrow LED$ , Red  $J \rightarrow DIP LED$ , Blue  $W \rightarrow EL$ , White  $O \rightarrow LED$ , Orange  $K \rightarrow DIP LED$ , White

 $M\rightarrow EL$ , Yellow Green  $G\rightarrow LED$ , Green  $E\rightarrow DIP$  LED, Yellow Green

F $\rightarrow$ CCFL, White P $\rightarrow$ LED, Blue H $\rightarrow$ DIP LED, Amber Y $\rightarrow$ LED, Yellow Green X $\rightarrow$ LED, Dual color I $\rightarrow$ DIP LED, Red

 $G\rightarrow$ LED, Green  $C\rightarrow$ LED, Full color

© LCD Mode : B→TN Positive, Gray V→FSTN Negative, Blue

N→TN Negative, T→FSTN Negative, Black

L→VA Negative D→FSTN Negative (Double film)

 $H \rightarrow HTN$  Positive, Gray  $F \rightarrow FSTN$  Positive  $I \rightarrow HTN$  Negative, Black  $K \rightarrow FSC$  Negative  $U \rightarrow HTN$  Negative, Blue  $S \rightarrow FSC$  Positive

M→STN Negative, Blue E→ISTN Negative, Black
G→STN Positive, Gray C→CSTN Negative, Black
Y→STN Positive, Yellow Green A→ASTN Negative, Black

② LCD Polarize A→Reflective, N.T, 6:00 H→Transflective, W.T,6:00

B→Transflective, N.T,6:00 I→Transmissive, W. T, 6:00 E→Transflective, N.T.12:00 L→Transmissive, W.T,12:00

Special Code
V : Built in negative voltage

Z:IC NT7086

#:Fit in with the ROHS Directions and regulations

### 2.Precautions in use of LCD Modules

- (1) Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6) Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.
- (8) Winstar have the right to change the passive components, including R3,R6 & backlight adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (9) Winstar have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Winstar have the right to modify the version.)
- (10) To ensure the stability of the display screen, please apply screen saver after showing 30 mins of fixed display content.

# **3.General Specification**

Item	Dimension	Unit				
Number of dots	128x64	_				
Module dimension	87.0 x 70.0 x 13.6 (MAX)	mm				
View area	72.0 x 40.0	mm				
Active area	66.52 x 33.24	mm				
Dot size	0.48 x 0.48	mm				
Dot pitch	0.52 x 0.52	mm				
LCD type	STN Positive, Yellow Green Transflective  (In LCD production, It will occur slightly color difference. We can only guarantee the same color in the same batch.)					
Duty	1/64					
View direction	6 o'clock					
Backlight Type	LED Yellow Green					
IC	RA6963					

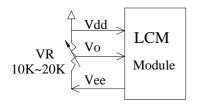
# **4.Absolute Maximum Ratings**

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	$T_{OP}$	-20	_	+70	$^{\circ}\!\mathbb{C}$
Storage Temperature	$T_{ST}$	-30	_	+80	$^{\circ}\!\mathbb{C}$
Input Voltage	V <sub>IN</sub>	-0.3	_	V <sub>DD</sub> +0.3	V
Supply Voltage For Logic	$V_{ m DD} ext{-}V_{ m SS}$	-0.3	_	+7.0	V
Supply Voltage For LCD	$V_{\mathrm{DD}}$ - $V_{\mathrm{0}}$	0	_	15	V

# **5.Electrical Characteristics**

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage For Logic	$V_{ m DD} ext{-}V_{ m SS}$	_	4.5	5.0	5.5	V
		Ta=-20°C	_	_	10.6	V
Supply Voltage For LCD	$V_{ m DD}$ - $V_0$	Ta=25°℃	8.2	8.5	8.8	V
*Note		Ta=70°C	7.6	_	_	V
Input High Volt.	$V_{\mathrm{IH}}$	_	0.8Vdd	_	$V_{\mathrm{DD}}$	V
Input Low Volt.	$V_{IL}$	_	0	_	$0.15~\mathrm{V_{DD}}$	V
Output High Volt.	V <sub>OH</sub>	_	V <sub>DD</sub> -0.3	_	$V_{DD}$	V
Output Low Volt.	$V_{\mathrm{OL}}$	_	0	_	0.3	V
Supply Current	$I_{\mathrm{DD}}$	_	12.0	16.0	18.0	mA

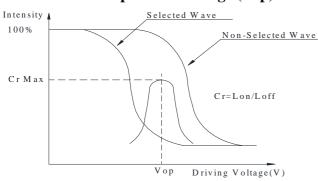
<sup>\*</sup> Note: Please design the VOP adjustment circuit on customer's main board

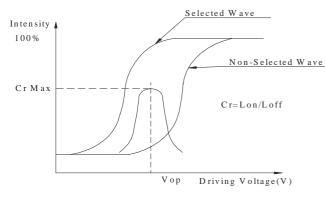


### **6.Optical Characteristics**

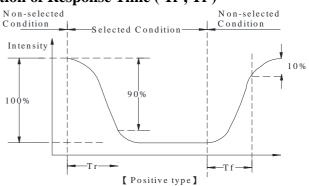
Item	Symbol	Condition	Min	Тур	Max	Unit
	θ	CR≧2	0	_	20	$\phi = 180^{\circ}$
<b>V</b> 7: <b>A</b> 1 -	θ	CR≧2	0	_	40	$\phi = 0^{\circ}$
View Angle	θ	CR≧2	0	_	30	$\phi = 90^{\circ}$
	θ	CR≧2	0	_	30	$\phi = 270^{\circ}$
Contrast Ratio	CR	_	_	3	_	_
Response Time	T rise	_	_	200	300	ms
	T fall	_	_	250	350	ms

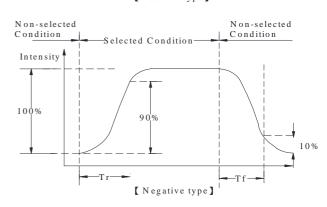
### **Definition of Operation Voltage (Vop)**





#### **Definition of Response Time (Tr, Tf)**



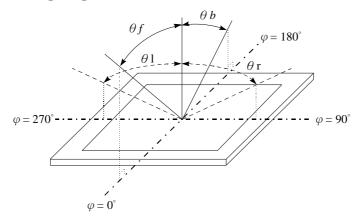


#### **Conditions:**

Operating Voltage : Vop Frame Frequency : 64 HZ Viewing Angle( $\theta$ ,  $\varphi$ ):  $0^{\circ}$ ,  $0^{\circ}$ 

Driving Waveform: 1/N duty, 1/a bias

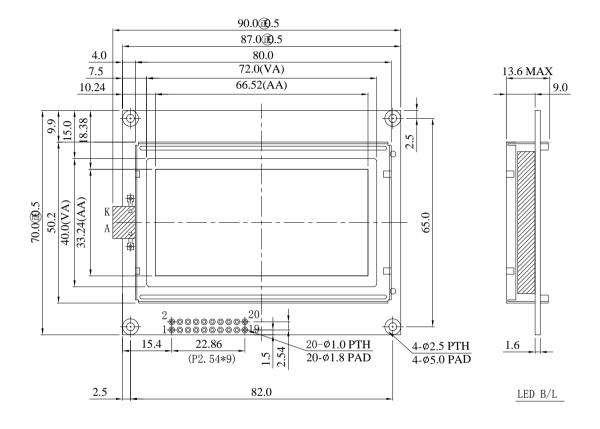
### Definition of viewing angle( $CR \ge 2$ )

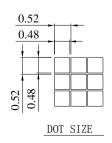


# **7.Interface Pin Function**

Pin No.	Symbol	Level	Description
1	Vss	_	GND
2	Vdd	_	Power supply
3	Vo	_	Power supply for LCD driver
4	C/D	H/L	WR=L, C/D=H: Command Write C/D=L: Data write
			RD=L, C/D=H: Status Read C/D=L: Data read
5	/RD	L	Data read. Read data from RA6963 when RD = L
6	/WR	L	Data write. Write data into RA6963 when WR = L
7	DB0	H/L	Data bus line
8	DB1	H/L	Data bus line
9	DB2	H/L	Data bus line
10	DB3	H/L	Data bus line
11	DB4	H/L	Data bus line
12	DB5	H/L	Data bus line
13	DB6	H/L	Data bus line
14	DB7	H/L	Data bus line
15	/CE	L	L : Chip enable
16	/RST	H/L	H: Normal; L: Initialize RA6963
17	Vee		Negative voltage output
18	MD2	H/L	Column select; H:32 column; L:40 column
19	FS1	H/L	Pins for selection of font; H: 6 * 8, L: 8 * 8
20	HLT	H/l	Clock operating stop signal

## **8.Contour Drawing & Block Diagram**





PIN NO.

5

6

8

9

10

11 12

13

14

15

16

17

18

19

SYMBOL

Vss

Vdd

Vo

C/D

RD WR

DB0

DB1

DB2

DB3 DB4

DB5

DB6

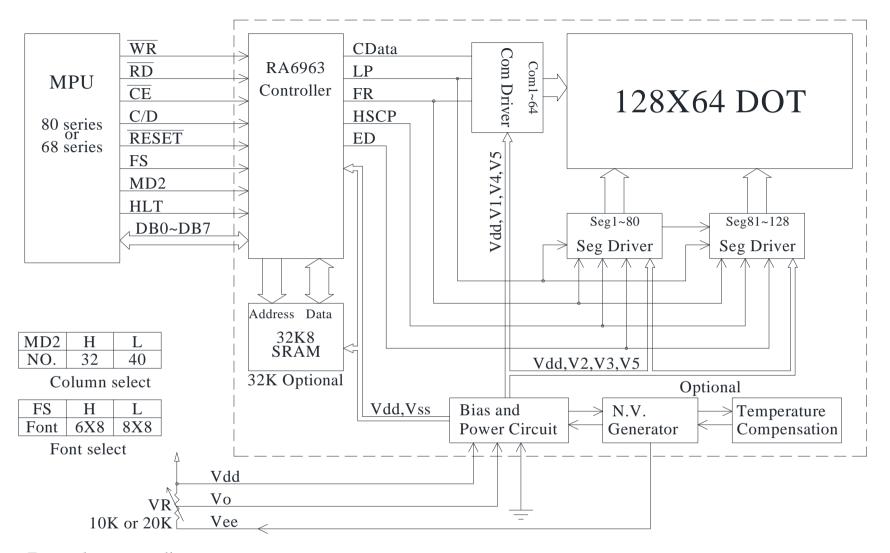
DB7 CE

RST

Vee

MD2

FS1 HLT



External contrast adjustment.

## 9.Reliability

Content of Reliability Test (Wide temperature, -20°C~70°C)

	Environmental Test							
Test Item	Content of Test	Test Condition	Not e					
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2					
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30°C 200hrs	1,2					
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs						
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1					
High Temperature/ Humidity storage	The module should be allowed to stand at 60 °C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C,90%RH 96hrs	1,2					
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation  -20°C 25°C 70°C  30min 5min 30min 1 cycle	-20°C/70°C 10 cycles						
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude: 1.5mm Vibration Frequency: 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3					
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=±600V(contact), ±800v(air), RS=330 Ω CS=150pF 10 times						

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal

Temperature and humidity after remove from the test chamber.

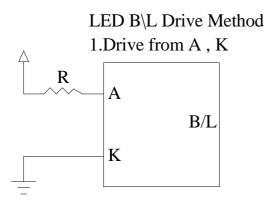
Note3: The packing have to including into the vibration testing.

## **10.Backlight Information**

### Specification

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION			
Supply Current	ILED	297	330	396	mA	V=4.2V			
Supply Voltage	V	4.0	4.2	4.4	V	_			
Reverse Voltage	VR	_	_	8	V	_			
Luminance (Without LCD)	IV	160	200	_	CD/M <sup>2</sup>	ILED=330mA			
Wave Length	λp	563	568	573	nm	ILED=330mA			
Life Time	_	_	100000	_	Hr.	ILED≤330mA 25°C,50-60%RH			
Color	Yellow Gre	Yellow Green							

Note: The LED of B/L is drive by current only, drive voltage is for reference only. drive voltage can make driving current under safety area (current between minimum and maximum).



# 11.Inspection specification

NO	Item	Criterion				AQL		
01	Electrical Testing	Missing character Display malfunct No function or no Current consump LCD viewing ang	Missing vertical, horizontal segment, segment contrast defect.  Missing character, dot or icon.  Display malfunction.  No function or no display.  Current consumption exceeds product specifications.  LCD viewing angle defect.  Mixed product types.  Contrast defect.					
02	Black or white spots on LCD (display only)	<ul> <li>2.1 White and black spots on display ≤0.25mm, no more than three white or black spots present.</li> <li>2.2 Densely spaced: No more than two spots or lines within 3mm</li> </ul>						
03	LCD black spots, white spots, contamination (non-display)	→ L +	Y	SIZE $\Phi \le 0.10$ $0.10 < \Phi \le 0.20$ $0.20 < \Phi \le 0.25$ $0.25 < \Phi$	Acceptable Q TY Accept no dense  2 1 0  Acceptable Q TY Acceptable Q TY Accept no dense  2 As round type	2.5		
04	Polarizer bubbles	If bubbles are vising black specifications, no to find, must check specify direction.	spot et easy ck in	Size Φ $\Phi \le 0.20$ $0.20 < \Phi \le 0.50$ $0.50 < \Phi \le 1.00$ $1.00 < \Phi$ Total Q TY	Acceptable Q TY Accept no dense 3 2 0 3	2.5		

NO	Item	Criterion			AQL	
05	Scratches	Follow NO.3 LCD black spots, white spots, contamination				
		Symbols Define:				
		x: Chip length y	: Chip width z: Ch	nip thickness		
		k: Seal width t	: Glass thickness a: LC	CD side length		
		L: Electrode pad length	1:			
		6.1 General glass chip				
		6.1.1 Chip on panel sur	rface and crack between	panels:		
			No.			
		z: Chip thickness	y: Chip width	x: Chip length		
	Chipped glass	Z≦1/2t	Not over viewing	x ≤ 1/8a		
06			area		2.5	
		$1/2t < z \le 2t$	Not exceed 1/3k	x ≤ 1/8a		
		∴ If there are 2 or more $6.1.2$ Corner crack: $z$ : Chip thickness $z \le 1/2t$	y: Chip width  Not over viewing area	of each chip. $ x \colon \text{Chip length}                                    $		
		$1/2t < z \le 2t$	Not exceed 1/3k	x ≤ 1/8a		
		⊙ If there are 2 or more chips, x is the total length of each chip.				

NO	Item	Criterion				
	Glass	Symbols: x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: LCD side length L: Electrode pad length 6.2 Protrusion over terminal: 6.2.1 Chip on electrode pad:				
06			≦1/8a	z: Chip thickness $0 < z \le t$	2.5	
		y: Chip width $y \le L$ ① If the chipped area touch remain and be inspected acc ① If the product will be head be damaged. 6.2.3 Substrate protuberance.	cording to electrode to at sealed by the custon	$\chi$ z: Chip thickness $0 < z \le t$ over 2/3 of the ITO must		

NO	Item	Criterion	
07	Cracked glass	The LCD with extensive crack is not acceptable.	
08		8.1 Illumination source flickers when lit.	0.65
	Backlight	8.2 Spots or scratched that appear when lit must be judged.	2.5
	elements	Using LCD spot, lines and contamination standards.	
		8.3 Backlight doesn't light or color wrong.	0.65
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.	2.5
	Bezer	9.2 Bezel must comply with job specifications.	0.65
		10.1 COB seal may not have pinholes larger than 0.2mm or contamination.	2.5
		10.2 COB seal surface may not have pinholes through to the IC.	2.5
		10.3 The height of the COB should not exceed the height	0.65
		indicated in the assembly diagram.	
	PCB、COB	10.4 There may not be more than 2mm of sealant outside the	2.5
		seal area on the PCB. And there should be no more than three	
		places.	
		10.5 No oxidation or contamination PCB terminals.	2.5
10		10.6 Parts on PCB must be the same as on the production	0.65
10		characteristic chart. There should be no wrong parts, missing	
		parts or excess parts.	
		10.7 The jumper on the PCB should conform to the product	0.65
		characteristic chart.	
		10.8 If solder gets on bezel tab pads, LED pad, zebra pad or	2.5
		screw hold pad, make sure it is smoothed down.	
		10.9 The Scraping testing standard for Copper Coating of PCB	2.5
		X	
		$\mathbf{Y}$ $\mathbf{X} * \mathbf{Y} \leq 2\mathbf{mm}^2$	
	Soldering	11.1 No un-melted solder paste may be present on the PCB.	2.5
		11.2 No cold solder joints, missing solder connections,	2.5
11		oxidation or icicle.	
		11.3 No residue or solder balls on PCB.	2.5
		11.4 No short circuits in components on PCB.	0.65

NO	Item	Criterion	AQL
		12.1 No oxidation, contamination, curves or, bends on interface	2.5
		Pin (OLB) of TCP.	
		12.2 No cracks on interface pin (OLB) of TCP.	0.65
		12.3 No contamination, solder residue or solder balls on product.	2.5
		12.4 The IC on the TCP may not be damaged, circuits.	2.5
		12.5 The uppermost edge of the protective strip on the interface	2.5
		pin must be present or look as if it cause the interface pin to sever.	
	General	12.6 The residual rosin or tin oil of soldering (component or chip	2.5
12		component) is not burned into brown or black color.	
	appearance	12.7 Sealant on top of the ITO circuit has not hardened.	2.5
		12.8 Pin type must match type in specification sheet.	0.65
		12.9 LCD pin loose or missing pins.	0.65
		12.10 Product packaging must the same as specified on packaging	0.65
		specification sheet.	
		12.11 Product dimension and structure must conform to product	0.65
		specification sheet.	
		12.12 Visual defect outside of VA is not considered to be rejection.	0.65

## **12.Material List of Components for**

### **RoHs**

1. WINSTAR Display Co., Ltd hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

Material	(Cd)	(Pb)	(Hg)	(Cr6+)	PBBs	PBDEs
Limited Value	100 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm
Above limited value is set up according to RoHS.						

- 2.Process for RoHS requirement : (only for RoHS inspection)
  - (1) Use the Sn/Ag/Cu soldering surface; the surface of Pb-free solder is rougher than we used before.
  - (2) Heat-resistance temp. :

Reflow:  $250^{\circ}$ C, 30 seconds Max.;

Connector soldering wave or hand soldering : 320°C, 10 seconds max.

(3) Temp. curve of reflow, max. Temp.  $: 235\pm5^{\circ}\mathbb{C}$ ;

Recommended customer's soldering temp. of connector: 280°C, 3 seconds.

# 13. Recommendable Storage

- 1. Place the panel or module in the temperature 25°C±5°C and the humidity below 65% RH
- 2. Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module.

		Feedback Sheet
Module Number :		Page: 1
1 · Panel Specification:		
1. Panel Type:	Pass	□ NG ,
2. View Direction:	Pass	□ NG ,
3. Numbers of Dots:	☐ Pass	□ NG ,
4. View Area:	Pass	□ NG ,
5. Active Area:	☐ Pass	□ NG ,
6. Operating Temperature:	Pass	□ NG ,
7. Storage Temperature:	Pass	□ NG ,
8. Others:		
2 · Mechanical Specification :		
1. PCB Size:	☐ Pass	□ NG ,
2. Frame Size:	Pass	□ NG ,
3. Materal of Frame:	Pass	□ NG ,
4. Connector Position:	Pass	□ NG ,
5. Fix Hole Position:	Pass	□ NG ,
6. Backlight Position:	Pass	□ NG ,
7. Thickness of PCB:	Pass	□ NG ,
8. Height of Frame to PCB:	Pass	□ NG ,
9. Height of Module:	Pass	□ NG ,
10. Others:	Pass	□ NG ,
3 · Relative Hole Size:		
1. Pitch of Connector:	Pass	□ NG ,
2. Hole size of Connector:	Pass	□ NG ,
3. Mounting Hole size:	Pass	□ NG ,
4. Mounting Hole Type:	Pass	□ NG ,
5. Others:	Pass	□ NG ,
4 · Backlight Specification :		
1. B/L Type:	☐ Pass	☐ NG ,
2. B/L Color:	Pass	☐ NG ,
3. B/L Driving Voltage (Refere	ence for LED	Type):   Pass   NG,
4. B/L Driving Current:	☐ Pass	☐ NG ,
5. Brightness of B/L:	Pass	☐ NG ,
6. B/L Solder Method:	Pass	☐ NG ,
7. Others:	Pass	☐ NG ,



	winstar		
Modu	le Number:		Page: 2
5、	Electronic Characteristics of	Module:	
1.	Input Voltage:	Pass	□ NG ,
2.	Supply Current:	Pass	□ NG ,
3.	Driving Voltage for LCD:	Pass	□ NG ,
4.	Contrast for LCD:	Pass	□ NG ,
5.	B/L Driving Method:	Pass	□ NG ,
6.	Negative Voltage Output:	Pass	□ NG ,
7.	Interface Function:	Pass	□ NG ,
8.	LCD Uniformity:	Pass	□ NG ,
9.	ESD test:	Pass	□ NG ,
10.	Others:	Pass	□ NG ,
6、	Summary:		
	Calagoianoterra		
	Sales signature: Customer Signature:		Data: / /
	Customer Signature .		Date: / /